imall

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Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





Features

- Any frequency between 1 MHz and 220 MHz accurate to 6 decimal places
- LVPECL and LVDS output signaling types
- 0.6ps RMS phase jitter (random) over 12 kHz to 20 MHz bandwidth
- Frequency stability as low as ±10 ppm
- Industrial and extended commercial temperature ranges
- Industry-standard packages: 3.2x2.5, 5.0x3.2 and 7.0x5.0 mmxmm
- For frequencies higher than 220 MHz, refer to SiT9122 datasheet

Electrical Characteristics

Applications

- 10GB Ethernet, SONET, SATA, SAS, Fibre Channel, PCI-Express
- Telecom, networking, instrumentation, storage, servers



Parameter and Conditions	Symbol	Min.	Тур.	Max.	Unit	Condition	
	L	VPECL an	d LVDS, C	ommon El	ectrical C	Characteristics	
Supply Voltage	Vdd	2.97	3.3	3.63	V		
		2.25	2.5	2.75	V		
		2.25	-	3.63	V	Termination schemes in Figures 1 and 2 - XX ordering code	
Output Frequency Range	f	1	-	220	MHz		
Frequency Stability	F_stab	-10	-	+10	ppm		
		-20	-	+20	ppm	Inclusive of initial tolerance, operating temperature, rated power	
		-25	I	+25	ppm	supply voltage, and load variations	
		-50	-	+50	ppm		
First Year Aging	F_aging1	-2	-	+2	ppm	25°C	
10-year Aging	F_aging10	-5	I	+5	ppm	25°C	
Operating Temperature Range	T_use	-40	I	+85	°C	Industrial	
		-20	-	+70	°C	Extended Commercial	
Input Voltage High	VIH	70%	-	-	Vdd	Pin 1, OE or ST	
Input Voltage Low	VIL	-	-	30%	Vdd	Pin 1, OE or ST	
Input Pull-up Impedance	Z_in	_	100	250	kΩ	Pin 1. OE logic high or logic low, or ST logic high	
		2	_	_	MΩ	Pin 1, ST logic low	
Start-up Time	T_start	-	6	10	ms	Measured from the time Vdd reaches its rated minimum valu	
Resume Time	T_resume	_	6	10	ms	In Standby mode, measured from the time \overline{ST} pin crosses 50% threshold.	
Duty Cycle	DC	45	-	55	%	Contact SiTime for tighter dutycycle	
		Ľ	VPECL, D	C and AC C	Characteri	istics	
Current Consumption	ldd	-	61	69	mA	Excluding Load Termination Current, Vdd = 3.3V or 2.5V	
OE Disable Supply Current	I_OE	_	-	35	mA	OE = Low	
Output Disable Leakage Current	I_leak	-	-	1	μA	OE = Low	
Standby Current	I_std	_	-	100	μA	ST = Low, for all Vdds	
Maximum Output Current	I_driver	_	-	30	mA	Maximum average current drawn from OUT+ or OUT-	
Output High Voltage	VOH	Vdd-1.1	-	Vdd-0.7	V	See Figure 1(a)	
Output Low Voltage	VOL	Vdd-1.9	_	Vdd-1.5	V	See Figure 1(a)	
Output Differential Voltage Swing	V_Swing	1.2	1.6	2.0	V	See Figure 1(b)	
Rise/Fall Time	Tr, Tf	_	300	700	ps	20% to 80%, see Figure 1(a)	
OE Enable/Disable Time	T_oe	-	-	115	ns	f = 212.5 MHz - For other frequencies, T_oe = 100ns + 3 period	
RMS Period Jitter	T_jitt	I	1.2	1.7	ps	f = 100 MHz, VDD = 3.3V or 2.5V	
		-	1.2	1.7	ps	f = 156.25 MHz, VDD = 3.3V or 2.5V	
		-	1.2	1.7	ps	f = 212.5 MHz, VDD = 3.3V or 2.5V	
RMS Phase Jitter (random)	T_phj	-	0.6	0.85	ps	f = 156.25 MHz, Integration bandwidth = 12 kHz to 20 MHz, all Vdds	
			LVDS, DC	and AC Ch	naracteris	tics	
Current Consumption	ldd	-	47	55	mA	Excluding Load Termination Current, Vdd = 3.3V or 2.5V	
OE Disable Supply Current	I_OE	-	-	35	mA	OE = Low	
Differential Output Voltage	VOD	250	350	450	mV	See Figure 2	

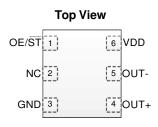


Electrical Characteristics(continued)

Parameter and Conditions	Symbol	Min.	Тур.	Max.	Unit	Condition		
LVDS, DC and AC Characteristics (continued)								
Output Disable Leakage Current	I_leak	-	-	1	μA	OE = Low		
Standby Current	I_std	-	-	100	μA	ST = Low, for all Vdds		
VOD Magnitude Change	ΔVOD	-	-	50	mV	See Figure 2		
Offset Voltage	VOS	1.125	1.2	1.375	V	See Figure 2		
VOS Magnitude Change	ΔVOS	-	-	50	mV	See Figure 2		
Rise/Fall Time	Tr, Tf	-	495	700	ps	20% to 80%, see Figure 2		
OE Enable/Disable Time	T_oe	-	-	115	ns	f = 212.5 MHz - For other frequencies, T_oe = 100ns + 3 period		
RMS Period Jitter	T_jitt	-	1.2	1.7	ps	f = 100 MHz, VDD = 3.3V or 2.5V		
		-	1.2	1.7	ps	f = 156.25 MHz, VDD = 3.3V or 2.5V		
		-	1.2	1.7	ps	f = 212.5 MHz, VDD = 3.3V or 2.5V		
RMS Phase Jitter (random)	T_phj	-	0.6	0.85	ps	f = 156.25 MHz, Integration bandwidth = 12 kHz to 20 MHz, all Vdds		

Pin Description

Pin	Мар	Functionality					
	OE	Input	H or Open: specified frequency output L: output is high impedance				
1	ST	Input	H or Open: specified frequency output L: Device goes to sleep mode. Supply current reduces to I_std.				
2	NC	NA	No Connect; Leave it floating or connect to GND for better heat dissipation				
3	GND	Power	VDD Power Supply Ground				
4	OUT+	Output	Oscillator output				
5	OUT-	Output	Complementary oscillator output				
6	VDD	Power	Power supply voltage				



Absolute Maximum

Attempted operation outside the absolute maximum ratings may cause permanent damage to the part. Actual performance of the IC is only guaranteed within the operational specifications, not at absolute maximum ratings.

Parameter	Min.	Max.	Unit
Storage Temperature	-65	150	°C
VDD	-0.5	4	V
Electrostatic Discharge (HBM)	-	2000	V
Soldering Temperature (follow standard Pb free soldering guidelines)	-	260	°C

Thermal Consideration

Package	hetaJA, 4 Layer Board (°C/W)	θJC, Bottom (°C/W)
7050, 6-pin	142	27
5032, 6-pin	97	20
3225, 6-pin	109	20

Environmental Compliance

Parameter	Condition/Test Method
Mechanical Shock	MIL-STD-883F, Method2002
Mechanical Vibration	MIL-STD-883F, Method2007
Temperature Cycle	JESD22, Method A104
Solderability	MIL-STD-883F, Method2003
Moisture Sensitivity Level	MSL1 @ 260°C



Waveform Diagrams

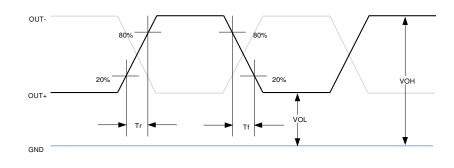


Figure 1(a). LVPECL Voltage Levels per Differential Pin (OUT+/OUT-)

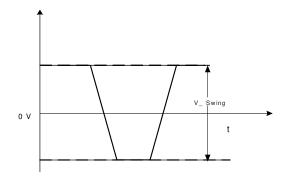


Figure 1(b). LVPECL Voltage Levels Across Differential Pair

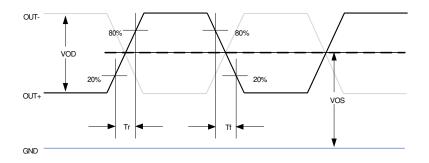


Figure 2. LVDS Voltage Levels per Differential Pin (OUT+/OUT-)



Termination Diagrams

LVPECL:

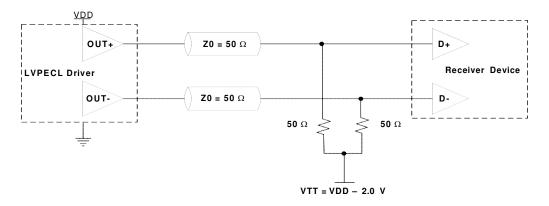


Figure 3. LVPECL Typical Termination

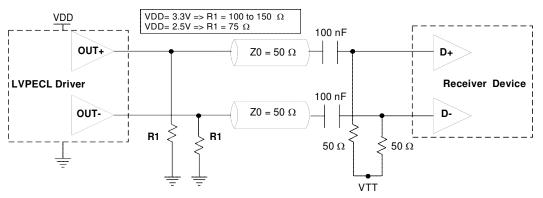
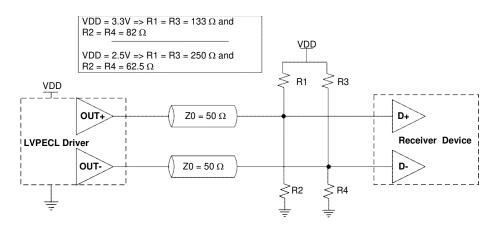
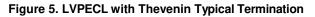


Figure 4. LVPECL AC Coupled Termination







LVDS:

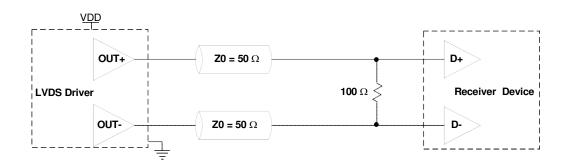
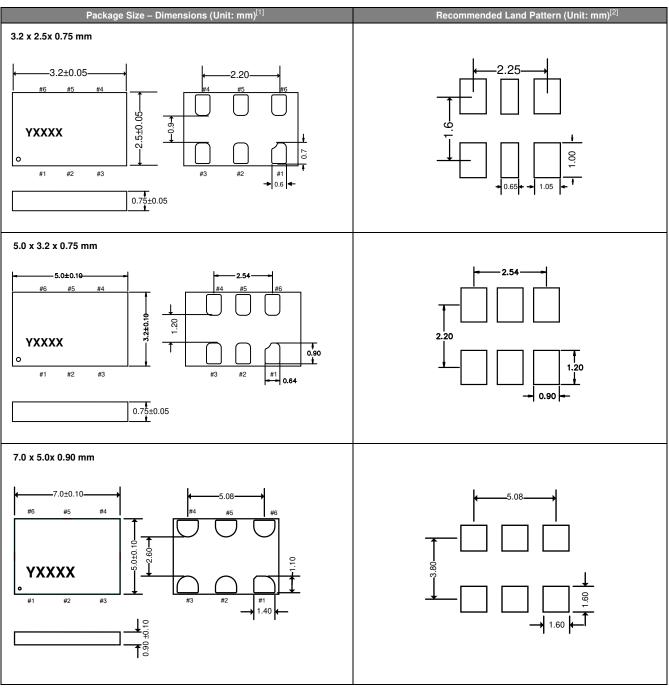


Figure 6. LVDS Single Termination (Load Terminated)



Dimensions and Patterns

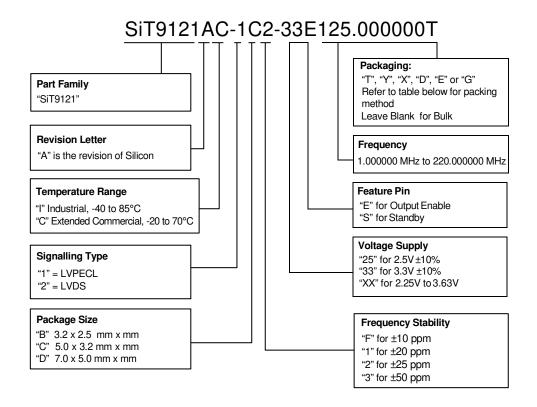


Notes:

- 1. Top Marking: Y denotes manufacturing origin and XXXX denotes manufacturing lot number. The value of "Y" will depend on the assembly location of the device.
- 2. A capacitor of value 0.1 μF between Vdd and GND is recommended.



Ordering Information



Ordering Codes for Supported Tape & Reel Packing Method

Device Size	8 mm T&R (3ku)	8 mm T&R (1ku)	8 mm T&R (250u)	12 mm T&R (3ku)	12 mm T&R (1ku)	12 mm T&R (250u)	16 mm T&R (3ku)	16 mm T&R (1ku)	16 mm T&R (250u)
7.0 x 5.0 mm	-	-	-	-	-	-	Т	Y	Х
5.0 x 3.2 mm	-	-	-	Т	Y	х	-	_	-
3.2 x 2.5 mm	D	E	G	Т	Y	Х	-	-	-

Frequencies Not Supported

Range 1: From 209.000001 MHz to 210.999999 MHz



Revision History

Version	Release Date	Change Summary
1.01	2/20/13	Original
1.02	12/3/13	Added input specifications, LVPECL/LVDS waveforms, packaging T&Roptions
1.03	2/6/14	Added 8mm T&R option and ±10 ppm
1.04	4/8/14	Included 1.8V option for LVDS output only
1.05	7/30/14	Included Thermal Consideration table
1.06	10/20/14	Modified Thermal Consideration values. Preliminary removed from the title
1.07	1/4/16	Removed 1.8V option

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